



SIM pin Assignment	PIN#	Name
C1	VCC	
C2	RST	
C3	CLK	
C5	GND	
C6	VPP	
C7	I/O	

■ CIRCUT TRACE KEEP OUT AREA
 ■ SMT SOLDER AREA
 THERE SHOULD NOT BE ANY CIRCUTRIES
 IN THE LAYOUT SPACE OF THE PRODUCTS.
 RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE ±0.05

NOTES:
 1) MATERIAL:
 HOUSING: LCP, PLASTIC UL 94V-0
 CONTACT: COPPER ALLOY
 SHELL: STAINLESS STEEL
 2) FINISH:
 CONTACT: GOLD FLASH PLATED ON CONTACT AREA;
 GOLD FLASH PLATED ON SOLDER TAILS,
 3) PART NO.:
 HY-SIM-002-P7

1: GOLD FLAME GP

NO	DATE	DESCRIPTION OF REVISION	DESIGNED	CHECKED	APPROVED	MATERIAL			SPECIFICATION			FINISH	QUANTITY	SCALE	
						DESIGNED	CHECKED	APPROVAL	규격	도번	표면처리				수량
변경일차	변경일차	변경내용	작성	검토	승인	작성	검토	승인						UNIT 단위	mm
						김도현	박재규	최국호							
DESIGNED						상원전자 주식회사									
작성						3RD ANGLE PROJ	HANYONES TECH CO.,LTD							FILE NO.	
							 한유안 ELECTRONICS CO.,LTD								